PM823

Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

Rev. 4 — 23 June 2022

Product data sheet PUBLIC

1 Product overview

The PM823 is an efficient low-cost power regulator. It consists of two 1.5 A buck regulators and one 525 mA LDO. The LDO can be powered by the buck converter output (≥1.6 V) to minimize the power loss and simplify the system thermal de-sign.

The PM823 is optimized for module applications. It minimizes the PCB footprint and BOM cost. The PM823 12-bump WLCSP package provides the smallest footprint for the state-of-the-art module applications. For general purpose applications, the 24-pin QFN package can meet the low-cost PCB requirements. The QFN package also provides additional functions such as power good outputs.

The PM823 Dynamic Voltage Scaling (DVS) feature supports the latest SoC and processor power control scheme. The PM823 also supports Adaptive Voltage Scaling (AVS). The serial interface can be used to program the device to meet different application requirements.

Features

- Supports 2.7 V~5.5 V operating voltage
- Two 1.5 A synchronous buck converters
- Single LDO supports up to 525 mA
- Ultra low 15 µA sleep current
- 3 MHz switching frequency
- · High output voltage accuracy
- Supports both DVS and AVS
- Single wire proprietary serial interface

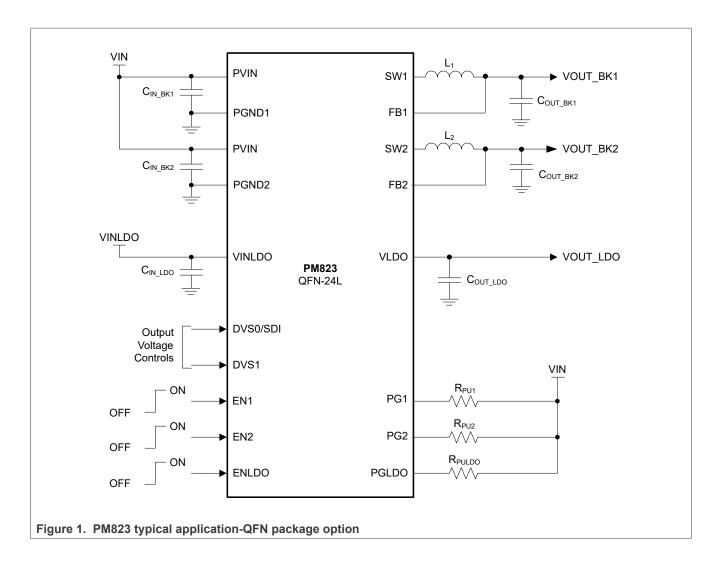
Package options

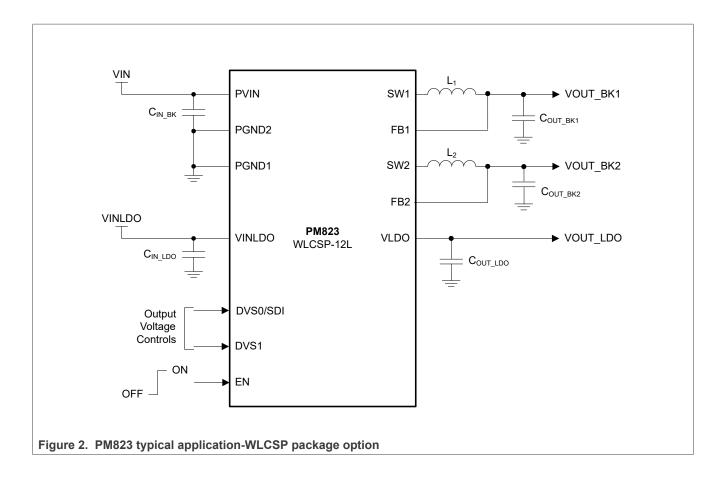
- WLCSP-12 lead (0.35 mm ball pitch)
- QFN-24 lead (0.5 mm pin pitch)

Applications

- · IoT devices
- · Wi-Fi modules
- · Smart home devices
- · Cameras, printers
- · Smart appliances
- Wi-Fi hubs, Access Points (APs)
- · Set top boxes

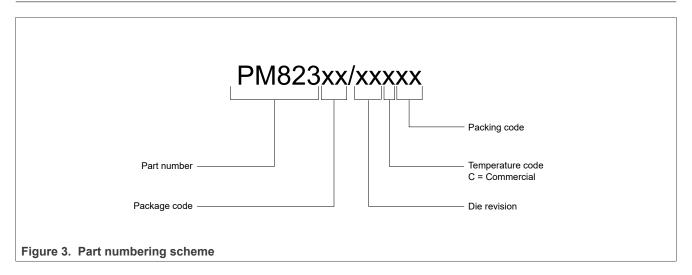






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2 Ordering information



The standard ordering part numbers for the respective solutions are the following:

Table 1. Part order options

Part order number	Buck1 output voltage	Buck2 output voltage	LDO output voltage	Package type
PM823UK/A0CZ (Tape and Reel)	1.1V	2.2V	1.8V	12-pad WLCSP
PM823HN/A0CHP (Tape and Reel)	1.1V	2.2V	1.8V	24-pin QFN

Note: Based on Marvell's 88PG823 RMA history, no RMA will be accepted except manufacturing defects. Device provided AS-IS and support limited to NXP Wi-Fi/ Bluetooth system related questions.

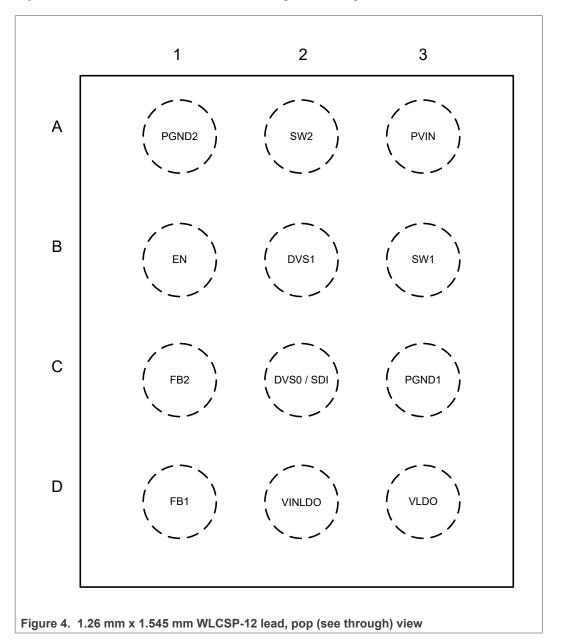
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3 Signal description

3.1 Pin configuration

3.1.1 12-lead WLCSP configuration

Figure 4 shows PM823 12-lead WLCSP configuration diagram.



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3.1.2 24-pin QFN configuration

Figure 5 shows PM823 24-pin QFN configuration diagram.

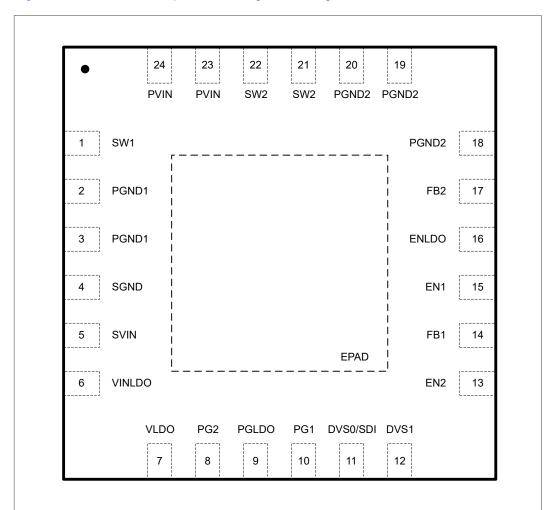


Figure 5. 4 mm x 4 mm QFN-24 in 0.5 mm pitch pin configuration, top (see through) view

3.2 Pin descriptions

Table 3 shows the pin description details for PM823.

Table 2. Pin types

Pin type	Description
I	Input
I/O	Input / Output
GND	Ground
NC	No Connection
S	Supply
0	Output

Table 3. Pin description

Pin number	in description	Pin name	Pin type	Function
WLCSP	QFN			
A1	18, 19, 20	PGND2	GND	Power ground for Buck2 regulator It must be connected to the negative terminals of the input and output capacitors All PGND pins must be connected to SGND, EPAD, and make a star connection to system ground Do not float any PGND pin
A2	21, 22	SW2	0	 Switch node for Buck2 regulator Internally connected to the drains of the high side and low side MOSFETs Connect to the external inductor When the switching regulator is disabled, the SW node is high impedance If step-down regulator 2 is not in use, float this pin
A3	23, 24	PVIN	S	Switching regulator power input Power input voltage. Internally connected to the source of the high side MOSFET Connect a ceramic input capacitor or an equivalent low ESR input capacitor between PVIN and PGND. Place it as close as possible to PVIN and PGND pins. See Section 8 "Application information". The voltage between SVIN and PVIN should be equal to 50mV or less All PVIN pins must be connected to the same voltage source Do not float any PVIN pin
B1	N/A	EN	I	 Enable Input for all regulators Logic high enables regulators and logic low disables regulators See Section 4 "Electrical specifications" for detailed logic high and logic low specifications When not in use, connect this pin to GND or connect a 0Ω resistor to GND Do not float this pin
B2	12	DVS1	I	Dynamic voltage scaling control 1 This digital input is used to select one of the three operating modes. See Section 5.6 "Operating modes" output voltage settings for mode selection. Do not float this pin
В3	1	SW1	0	 Switch node for buck1 regulator Internally connected to the drains of the high side and low side MOSFETs Connect to the external inductor When the switching regulator is disabled, the SW node is high impedance If Step-down Regulator 1 is not in use, float this pin
C1	17	FB2	I	Buck2 regulator output voltage sense feedback Connect this pin to the output capacitor This pin senses the output voltage of the switching regulator Do not float this pin

Table 3. Pin description...continued

Table 3. F	in description	icommueu				
Pin						
number		Pin name	Pin type	Function		
WLCSP	QFN					
C2	11	DVS0/SDI	I	 Dynamic voltage scaling control 0 / serial data input This digital input pin has two functions If DVS1=0, this pin is used as DVS0 input If DVS1=1, this pin becomes the one wire serial interface input Input data into this pin is used to program the output voltage (see Section 5.2 "Serial interface (1-wire)") When not in use, connect this pin to GND or connect a 0Ω resistor to GND See Section 5.7 "DVS output voltage settings" for mode selection Do not share this pin with other serial interface pins Do not float this pin 		
C3	2, 3	PGND1	GND	Power ground for Buck1 regulator This pin must be connected to the negative terminals of the input and output capacitors All PGND pins must be connected to SGND, EPAD, and make a star connection to system ground Do not float this pin		
D1	14	FB1	I	Buck1 regulator output voltage sense feedback Connect this pin to the output capacitor This pin senses the output voltage of the switching regulator Do not float this pin		
D2	6	VIN-LDO	S	 LDO power supply This is the power supply input for the LDO Regulator Connect a ceramic input capacitor or an equivalent low ESR input capacitor between this pin and the ground plane. Place it as close as possible to this pin and the ground plane. See Section 8 "Application information". 		
D3	7	VLDO	0	 LDO output This pin is the output of the LDO Connect a ceramic output capacitor or an equivalent low ESR output capacitor between this pin and the ground plane. Place it as close as possible to this pin and the ground plane. See <u>Section 8 "Application information"</u>. 		
N/A	4	SGND	GND	Signal ground This pin must be connected to SGND, all PGNDx pins, and make star connection to system ground Do not float this pin		
N/A	5	SVIN	S	 Signal input voltage This is the input voltage pin to the internal circuitry. See Section 4.4 "Electrical characteristics" for input voltage range. Connect a decoupling ceramic capacitor or an equivalent low ESR decoupling capacitor between SVIN and SGND and position it as close as possible to the IC. See Section 8 "Application information". The voltage between SVIN and PVIN should be equal to 50mV or less Do not float this pin 		

Table 3. Pin description...continued

Pin	•					
number		Pin name	Pin type	Function		
WLCSP	QFN					
N/A	8	PG2	0	 Buck2 regulator power good output This pin is an open-drain output Connect a 100kΩ pull-up resistor from this pin to VOUT or a logic that is equal to or less than SVIN The PG is held low when the output voltage is outside its regulatio band and goes high after the output voltage is within regulation When not in use, float this pin In shutdown, the PG will be actively low 		
N/A	9	PGLDO	0	 LDO power good This pin is an open-drain output Connect a 100kΩ pull-up resistor from this pin to VOUT or a logic rethat is equal to or less than SVIN The PG is held low when the output voltage is outside its regulation band and goes high after the output voltage is within regulation When not in use, float this pin In shutdown, the PG will be actively low 		
N/A	10	PG1	0	 Buck1 regulator power good output This pin is an open-drain output Connect a 100kΩ pull-up resistor from this pin to VOUT or a logic rail that is equal to or less than SVIN The PG is held low when the output voltage is outside its regulation band and goes high after the output voltage is within regulation When not in use, float this pin In shutdown, the PG will be actively low 		
N/A	13	EN2		 See Section 5.4 "Power-up sequence" to determine which part numbers have power sequences versus those that do not For part numbers with a power sequence in the QFN-24 package, EN1, EN2, and ENLDO pins need to be connected together. Any logic high from EN1, EN2, and ENLDO pins enables all regulators. EN1, EN2, and ENLDO need to have logic low to disable all regulators. User can not individually enable or disable each stepdown regulator for parts with a power sequence For part numbers without a power sequence, logic high for this pin enables Step-down Regulator 2. Logic low for this pin disables Stepdown Regulator 2 When not in use, connect this pin to GND or connect a 0Ω resistor to ground Do not float this pin 		

Table 3. Pin description...continued

Pin number	n descriptio	Pin name	Pin type	Function	
WLCSP	QFN				
N/A	15	EN1		 Buck1 enable input See Section 5.4 "Power-up sequence" to determine which part numbers have power sequences versus those that do not For part numbers with a power sequence in the QFN-24 package EN1, EN2, and ENLDO pins need to be connected together. Any logic high from EN1, EN2, and ENLDO pins enables all regulator EN1, EN2, and ENLDO need to have logic low to disable all regulators. User can not individually enable or disable each stepdown regulator for parts with a power sequence For part numbers without a power sequence, logic high for this pienables Step-down Regulator 1. Logic low for this pin disables Step-down Regulator 1 When not in use, connect this pin to GND or connect a 0Ω resisting ground Do not float this pin 	
N/A	16	ENLDO		 LDO enable input See Section 5.4 "Power-up sequence" to determine which part numbers have power sequences versus those that do not For part numbers with a power sequence in the QFN-24 package, EN1, EN2, and ENLDO pins need to be connected together. Any logic high from EN1, EN2, and ENLDO pins enables all regulators. EN1, EN2, and ENLDO need to have logic low to disable all regulators. User can not individually enable or disable each stepdown regulator for parts with a power sequence For part numbers without a power sequence, logic high for this pin enables the LDO Regulator. Logic low for this pin disables the LDO Regulator When not in use, connect this pin to GND or connect a 0Ω resistor to ground The voltage on this pin must never be higher than the voltage on the SVIN pin + 0.3V for all conditions Do not float this pin 	
N/A	25	EPAD	GND	 Exposed thermal pad This pin must be connected to SGND, all PGND pins, and make a star connection to system ground. See <u>Section 8 "Application information"</u>. Do not float this pin 	

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Electrical specifications

4.1 Absolute maximum ratings

Table 4. Absolute maximum ratings^[1]

Parameter	Range	Unit
V _{SVIN} to SGND	-0.3 to +6.0	V
S _{VIN}	V _{PVINx} -0.3 to V _{PVINx} +0.3	V
V _{PVINx} to PGNDx	-0.3 to +6.0	V
V _{SWx} to PGNDx ^[2]	-0.3 to (V _{PVINx} +0.3)	V
SGND to PGNDx	-0.3 to +0.3	V
V _{EN} , V _{EN_LDO} , V _{EN1} , V _{EN2}	-0.3 to (V _{SVIN} +0.3)	V
V _{DVS0/SDI} , V _{DVS1}	-0.3 to +6.0	V
Maximum junction temperature	150	°C
Storage temperature range	-65 to 150	°C

Exceeding the absolute maximum rating may damage the device. SWx is capable of sustaining -1.0V for less than 50 ns.

4.2 Recommended operating conditions

Table 5. Recommended operating conditions^[1]

Symbol	Parameter	Min	Тур	Max	Unit
V _{PVIN}	Buck input power voltage	2.7		5.5	V
V _{INLDO}	LDO input power voltage	1.6		5.5	V
T _{JMAX}	Maximum operating junction temperature			125	°C
Θ _{JA}	Package thermal resistance (WLCSP-22L)		40		°C/W
Θ_{JA}	Package thermal resistance (QFN-24L)		50		°C/W
T _A	Operating ambient temperature range	-40		85	°C

Specifications over the -40°C to 85°C operating temperature ranges are assured by design, characterization and correlation with statistical process controls.

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4.3 External passive components

Table 6. External passive components

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C _{IN1_BK} (WLCSP), C _{IN1_BK1} , C _{IN1_BK2} ,	External components	The distance between this capacitor to PVINx and PGNDx must be less than 1 mm. The maximum case size is 0201 (0603 metric). Use capacitor with ±30% tolerance or better.	0.10	0.22		μF
C _{IN2_BK}		WLCSP package: Use capacitor with ±30% tolerance or better.	2 x 10			μF
C _{IN2_BK1} , C _{IN2_BK2}		QFN package: Use capacitor with ±30% tolerance or better.	10			μF
C _{OUT_BK1} , C _{OUT_BK2}		Use capacitor with ±30% tolerance or better.	22			μF
L _{BK1} , L _{BK2}		Use capacitor with ±30% tolerance or better.		1.0		μН
LC _{BK1} , LC _{BK2}		The nominal L _{BUCKx} x the TOTAL nominal C _{OUT} _{BUCKx} must not exceed this maximum specification. Use inductor and capacitor with ±30% tolerance or better.			60	µН х µF
C _{IN_LDO}		Use capacitor with ±30%	10			μF
C _{OUT_LDO}		tolerance or better.	4.7		20	

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4.4 Electrical characteristics

Table 7. Electrical characteristics

The following applies unless otherwise noted: Refer to the schematics shown in <u>Section 8.2 "PCB schematics"</u>. V_{IN} = 3.6V, T_A = -40°C to +85°C.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
Supply current						
I _{Q_MODE1} / I _{Q_MODE2}	Active modes quiescent current	Active Mode 1 and Mode 2: Buck1 and Buck2 are in PFM mode and LDO is on. V _{IN} =5V. No load.		170		μА
		Active mode 1 and mode 2: Buck1 and Buck2 are in PWM mode and LDO is on. V _{IN} =5V. No load.		20		mA
I _{Q_MODE3}		Active mode 3: Buck1 and Buck2 are in PFM mode and LDO is on. V _{IN} = 5V. No load.		75		μА
		Active mode 3: Buck1 and Buck2 are in PWM mode and LDO is on. V _{IN} = 5V. No load.		20		mA
I_{Q_SLP}	Sleep mode quiescent current	$V_{DVS0} = V_{DVS1} = 0V.$ $V_{IN} = 5V.$ No load.		15		μА
I _{SHDN}	Shutdown current	V _{ENx} = 0V. V _{IN} = 5V		1		μA
Buck1 and Buck2				1	1	1
V _{PVIN}	Power supply input		2.7		5.5	V
I _{OUT_BK1} / I _{OUT_BK2}	Maximum output current in full power mode		1.5			А
I _{OUT_B} -K1_SLP / I _{OUT_B} -K2_SLP	Maximum output current in sleep mode		10			mA
V _{OUT_BK1} / V _{OUT_BK2}	Nominal output voltage	Programmable	0.6		3.3	V
RDS _{PMOS}	High-side (PMOS) on- resistance	V _{IN} = 3.6V		80		mΩ
RDS _{NMOS}	Low-side (NMOS) on- resistance	V _{IN} = 3.6V		40		mΩ
F _{SW}	Switching frequency			3		MHz
DUTY _{MAX}	Maximum duty cycle				100	%
V _{DC_ACCY}	V _{OUT} DC accuracy			±2		%
V _{LN_REG}	Line regulation	V _{IN} = 2.7 V to 5.5 V at I _{OUT} = 500 mA		0.1		%/V

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Table 7. Electrical characteristics...continued

The following applies unless otherwise noted: Refer to the schematics shown in Section 8.2 "PCB schematics". $V_{IN} = 3.6V_{IN}$

 $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}.$ **Symbol Parameter Conditions** Min Units Тур Max I_{OUT} = 100 mA to Load regulation 0.2 %/A V_{LD} REG 1500 mA BUCKx PG rising **PGx_{VTH}** 95 %/V_{OUT} threshold BUCKx PG hysteresis 5 **PGXHYS** %/V_{OUT} V_{OUT} dynamic voltage DV_{RAMP_RATE} 7 mV/µs ramp rate LDO Power supply input 1.6 5.5 ٧ V_{IN LDO} Maximum output current |--525 mΑ I_{OUT_LDO_}-MAX in full power mode Minimum LDO load 5 μΑ IOUT LDO MIN current Maximum output current |--10 mA IOUT LDO SLP in sleep mode Nominal output voltage Programmable (device 1.2 ٧ V_{OUT_LDO} 3.3 part number dependent) LDO output accuracy % V_{LDO_D}-C_ACCY +2 V_{OUT} = 1.8 V; I_{OUT} = mV V_{DROP} Dropout voltage 100 100 mA $V_{IN} = 2.7 \text{ V to } 5.5 \text{ V at}$ Line regulation 0.05 %/V V_{LDO L-N REG} I_{OUT} = 100 mA $I_{OLIT} = 100 \text{ mA to}$ % Load Regula-tion $V_{LDO_LD_REG}$ 500 mA LDO PG rising threshold PGLDO_{VTH} 95 %/V_{OUT} PGLDO_{HYS} LDO PG hysteresis 5 **Fault protection** V V_{UVLO} VIN under Vvltage lock-VIN increasing 2.35 out Hysteresis 0.1 V V_{OVP} VIN over voltage VIN increasing 5.7 protection Hysteresis 0.1 Over-temperature °C T_{OTS} Temperature rising 145 thermal shutdown Hysteresis 20 Digital input thresholds $V_{SVIN} = 2.5V \text{ to } 5.5V$ ٧ V_{IH} High level input voltage 1.2 threshold (EN, EN1, EN2, ENLDO, DVS0/ SDI, DVS1)

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Table 7. Electrical characteristics...continued

The following applies unless otherwise noted: Refer to the schematics shown in <u>Section 8.2 "PCB schematics"</u>. V_{IN} = 3.6V, T_A = -40°C to +85°C.

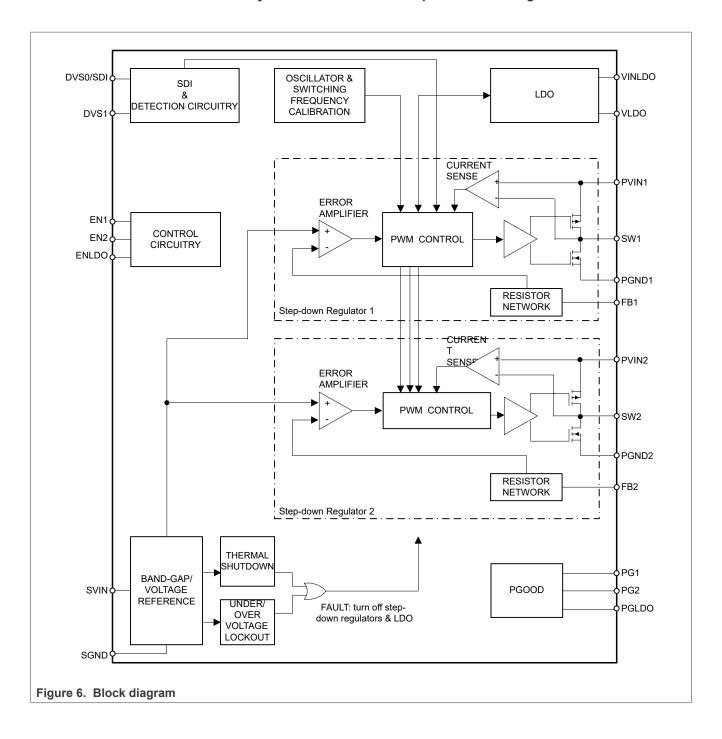
Symbol	Parameter	Conditions	Min	Тур	Max	Units
V_{IL}	Low level input voltage threshold (EN, EN1, EN2, ENLDO, DVS0/ SDI, DVS1)	V _{SVIN} = 2.5V to 5.5V			0.4	V

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5 Functional description

5.1 Overview

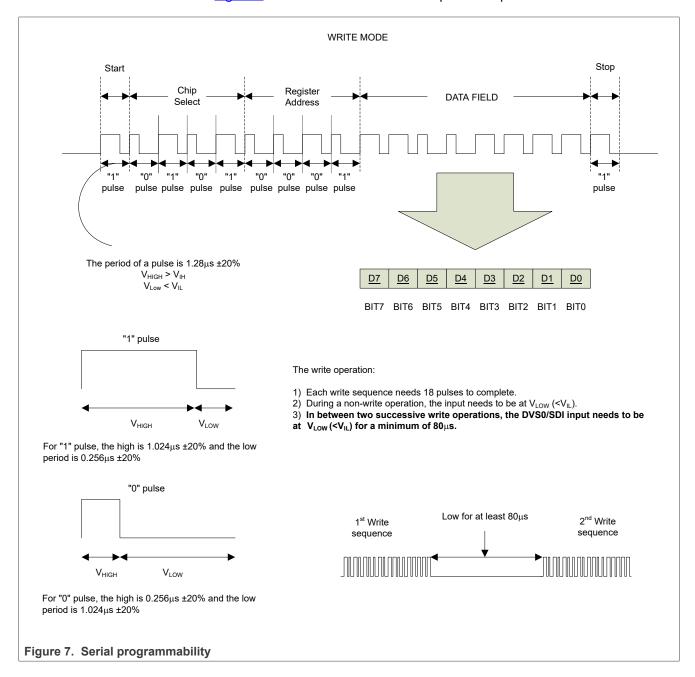
The PM823 is a performant power management regulator as well as a general purpose power management regulator for portable applications. The PM823 includes two stepdown switching (Buck) regulators and one Low Dropout (LDO) regulator. The switching step-down regulators utilize a proprietary internally compensated PWM control to regulate its respective output voltages that require no additional external compensation. The PM823 operates from an input voltage range of 2.7V to 5.5V. The LDO regulator can operate with an input voltage ranging from 100 mV above its regulation point to 5.5V. Each of the two switching regulators can deliver a maximum continuous load of 1.5A at 3 MHz switching frequency; while the LDO can deliver a continuous load current of up to 525 mA. Figure 6 shows the PM823 block diagram.



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5.2 Serial interface (1-wire)

The PM823 uses the 1-wire interface. The input for the serial interface is the DVS0 pin, but this functionality is only enabled when the DVS1 pin is set to a high state. Please note SDI capability is not available in sleep mode as this mode requires DVS0=DVS1=Low. The frequency of the SDI interface is 781.25kHz, and has a 20% tolerance. Figure 7 illustrates the serial interface pulse setup.



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5.3 Soft start

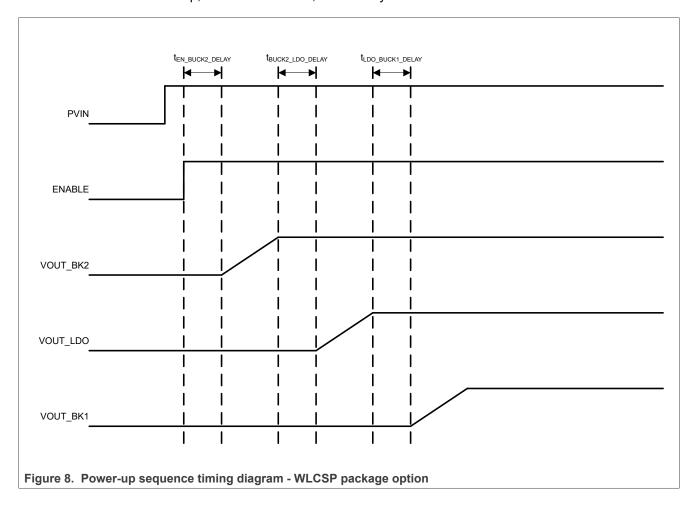
The PM823 internally controls the inrush current when the regulator is enabled. This is accomplished by ramping up the desired output voltage based on steps for a predetermined amount of time. Allowing the output voltage to ramp up in this fashion minimizes the current required to charge the output capacitance, therefore limiting the inrush current.

The LDO typical soft start current limit is 50 mA. After the soft start timer has expired (~1 ms), the LDO outputs the full current.

5.4 Power-up sequence

For PM823 with WLCSP package, the EN pin controls the output sequence for all 3 regulators.

For PM823 with QFN package, it is recommended that EN1, EN2 and ENLDO are connected together. Once the part is enabled, Buck2 initializes. After Buck2 completes its start-up, the LDO initializes, followed by Buck1.



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5.5 Power good

The PM823 contains a power good comparator which pulls low when the output voltage falls below 90% of its regulated value, or when the output voltage is above 95% of its regulated value when the output voltage is rising. The PGOOD output is an opendrain transistor which is off and becomes high impedance when the output voltage is in regulation. This high impedance state allows an external resistor to pull the PGOOD pin high when this transistor is off, or when the buck regulator is disabled via the enable pin.

5.6 Operating modes

The PM823 supports four operating modes selected by the Dynamic Voltage Scaling (DVS) pins and the internal register as shown in <u>Table 8</u>. Each operating mode provides different power saving features to meet different application needs. For example, even if the serial interface is not used, the DVS pins are still able to provide the power saving feature.

Table 8. Operating mode selections

такіс сі Ср	able 6. Operating mode selections						
Operating mode	DVS1	DVS0	Reg 0x05 bit [2]	Functional description			
Active Mode 1	High	SDI	X (don't care)	Full power mode and the serial interface (pin DVS0) is enabled			
Active Mode 2	Low	High	1	Full power mode, but the serial interface is disabled			
Active Mode 3	Low	High	0	Automatic power saving mode and the serial interface is disabled			
Sleep Mode	Low	Low	1	Lowest power mode and the serial inter-face is disabled			

The PM823 supports two full power modes, Active Mode 1 and Active Mode 2. Both full power modes have the same power consumption. The major differences are first that the serial interface is not enabled in Active Mode 2, and second that the buck1 regulator can be programmed to different output voltages in Active Modes 1 and 2 to support different applications.

When the PM823 is set to Active Mode 3, the internal clock automatically turns off during a light load (PFM) condition to reduce the system power consumption, but the output voltage remains the same as in Active Mode 1. Active Mode 3 improves the system power consumption if the serial interface is not used.

The PM823 also supports the Sleep Mode function which minimizes the system power during a low power mode event. The PM823 quiescent current is reduced to 15 μ A during Sleep Mode. However, during Sleep Mode, the maximum output current for each regulator is limited to 10 mA. If the load current is increased beyond the limit, the over current protection mechanism kicks in and shuts down the output voltage. The buck1 output voltage can be set through Register 0x02.

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5.7 DVS output voltage settings

The PM823 buck1 output voltage can be set to different output voltages in different operating modes through the internal registers. The buck2 and LDO output voltages can be changed as well during Active Mode 1 through programming. However, the buck2 and LDO remain the same across different operating modes.

Table 9. DVS output voltage settings

Operating mode	DVS1	DVS0	Reg 0x05 bit [2]	Buck1 output voltage settings
Active Mode 1	High	SDI	X (don't care)	See Section 10.3.1 "Buck1 active mode 1 and mode 3 output voltage control".
Active Mode 2	Low	High	1	See Section 10.3.2 "Buck1 active mode 2 output voltage control".
Active Mode 3	Low	High	0	See Section 10.3.1 "Buck1 active mode 1 and mode 3 output voltage control".
Sleep Mode	Low	Low	1	See Section 10.3.3 "Buck1 sleep mode output voltage control".

The time to change from one output voltage level to another can be calculated with the following equation:

$$t_{DV} = \frac{|V_{OUT_CURRENT} - V_{OUT_NEW}|}{DV_{RAMP_RATE}}$$

Example:

 $V_{OUT_CURRENT} = 1.2000V$ $V_{OUT_NEW} = 1.2500V$ $DV_{RAMP_RATE} = 7 \text{ mV/}\mu\text{s}$ $7.1429\mu\text{s} = \frac{|1.2000V - 1.2500V|}{(7mV)/(\mu\text{s})}$

5.8 Sleep mode

The PM823 supports the sleep mode function which saves power when the system is in low power mode. The maximum output current for each regulator is limited to 10 mA. If the load current is increased beyond the sleep mode current limit, the PM823 over-current protection kicks in and shuts down the corresponding output. The DVS0 and DVS1 pins are used to set the PM823 to different operating modes. Before entering sleep mode, the host needs to enable the DVS function by setting the REG5 bit[2] to 1. The sleep mode buck1 output voltage can be preprogrammed using REG0 bit[6:5] and REG2 bit[4:0]. The PM823 enters sleep mode when all the required registers are set and both DVS0 and DVS1 pins are asserted to low.

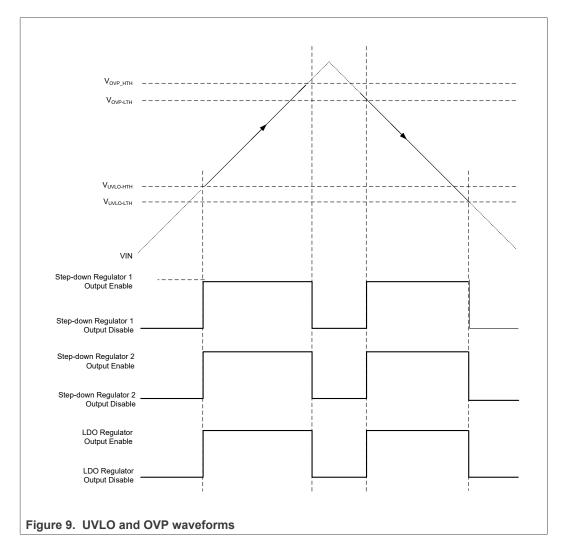
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5.9 Under voltage lock-out (UVLO)

This feature ensures that both internal MOSFETs for the step-down regulators and for the LDO regulator have adequate voltage levels to operate. When the input voltage is below UVLO low threshold, both MOSFETs for the step-down regulators and for the LDO regulator are off until the input rises above the UVLO high threshold. The switching nodes (SW) for both step-down regulators are in high Z state when the input voltage is less than UVLO high threshold.

5.10 Over voltage protection (OVP)

An over-voltage comparator guards against line transient overshoots, as well as other serious conditions that may damage the IC. When the input voltage is above OVP high threshold the output turns off and the switching node (SW) for both step-down regulators are high Z. The device will remain at this state until the input voltage comes back below OVP low threshold.



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5.11 Over-temperature thermal shutdown (OTS)

When the junction temperature exceeds OTS high threshold, the thermal shutdown circuitry disables the PM823. The device is enabled again once the junction temperature is below OTS low threshold.

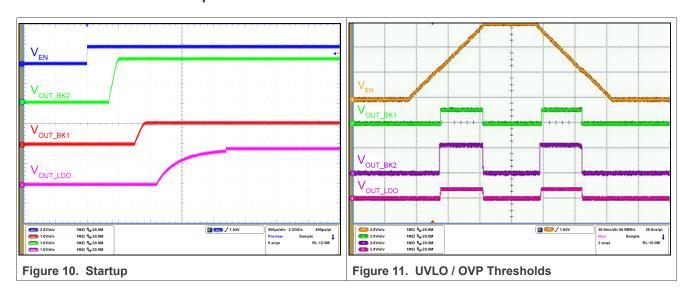
Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

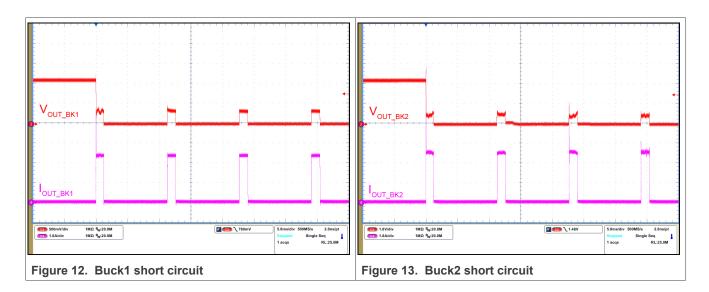
6 Functional characteristics

See Section 8.2 "PCB schematics". The following applies unless otherwise noted: $T_A = 25$ °C.

 V_{IN} = 5V, V_{OUT_BK1} = 1.1V, V_{OUT_BK2} = 2.2V, and V_{OUT_LDO} = 1.8V.

6.1 Start-up waveforms





Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

6.2 Load transient waveforms

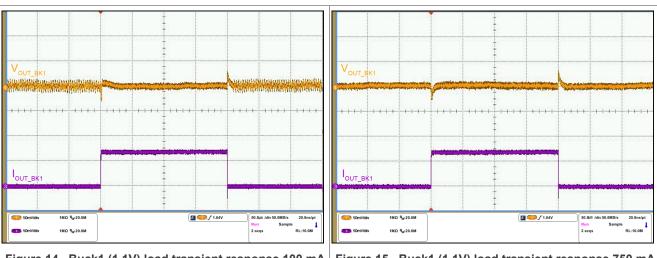


Figure 14. Buck1 (1.1V) load transient response 100 mA to 750 mA

Figure 15. Buck1 (1.1V) load transient response 750 mA to 1.5A

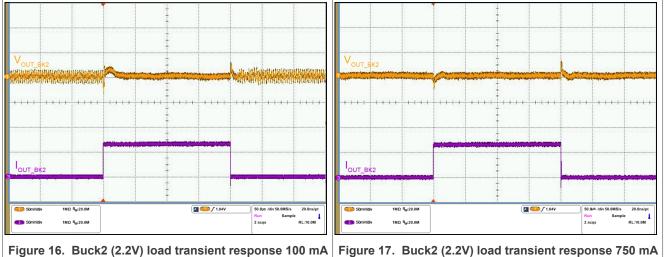
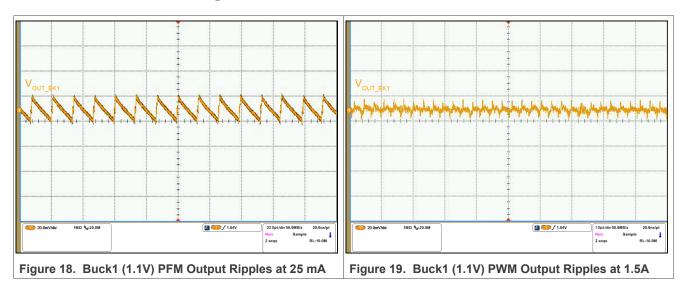


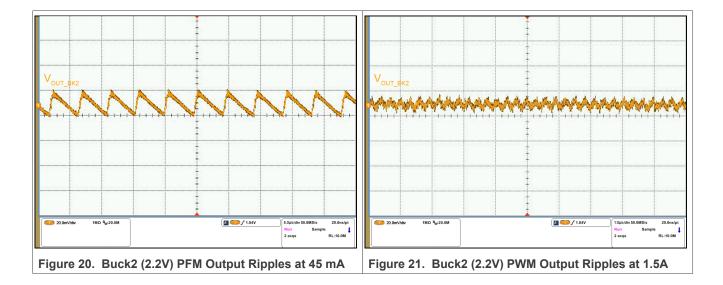
Figure 16. Buck2 (2.2V) load transient response 100 mA to 750 mA

to 1.5A

Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

6.3 Switching waveforms





Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

Typical characteristics 7

Unless otherwise noted, the following typical scope photographs were taken using the test circuits shown in Section 8.2 "PCB schematics" at $T_A = 25$ °C.

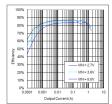


Figure 22. Buck1 (1.1V) efficiency vs output current WLCSP-12

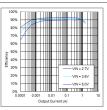


Figure 23. Buck2 (2.2V) efficiency vs output current WLCSP-12

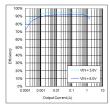


Figure 24. Buck1 (3.3V) efficiency vs output current QFN-24

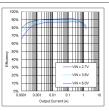


Figure 25. Buck2 (1.8V) efficiency vs output current QFN-24

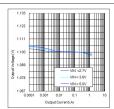
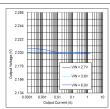
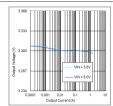


Figure 26. Buck1 (1.1V) output voltage vs output current Figure 27. Buck2 (2.2V) output voltage vs output current WLCSP-12



WLCSP-12



QFN-24

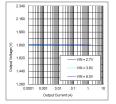


Figure 28. Buck1 (3.3V) output voltage vs output current Figure 29. Buck2 (1.8V) output voltage vs output current QFN-24

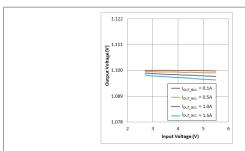


Figure 30. Buck1 output voltage vs input voltage WLCSP-12

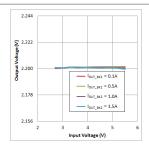
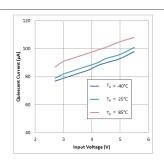


Figure 31. Buck2 Output Voltage vs Input Voltage WLCSP-12



(BK1=1.1V, BK2=2.2V, LDO=1.8V, V_{INLDO} connect to V_{INBUCK})

Figure 32. Quiescent Current vs Input Voltage For Active Mode 3

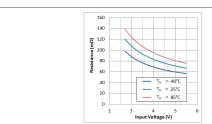


Figure 33. Buck1 high side $R_{DS(ON)}$ vs. input voltage WLCSP-12

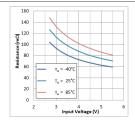


Figure 34. Buck2 high side $R_{\text{DS(ON)}}$ vs. input voltage WLCSP-12

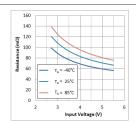


Figure 35. Buck1 low side $R_{\text{DS(ON)}}$ vs. input voltage WLCSP-12

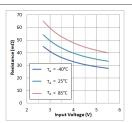


Figure 36. Buck2 low side $R_{\text{DS(ON)}}$ vs. input voltage WLCSP-12

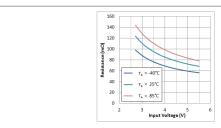


Figure 37. Buck1 high side $R_{DS(ON)}$ vs. input voltage QFN-24

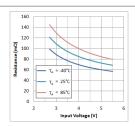


Figure 38. Buck2 high side $R_{DS(ON)}$ vs. input voltage QFN-24

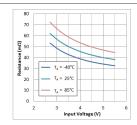


Figure 39. Buck1 low side $R_{DS(ON)}$ vs. input voltage QFN-24

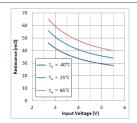


Figure 40. Buck2 low side $R_{\text{DS(ON)}}$ vs. input voltage QFN-24

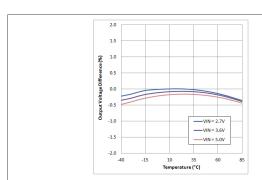


Figure 41. Buck1 Output Voltage Error vs Temperature

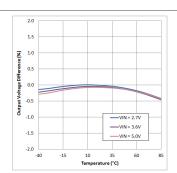
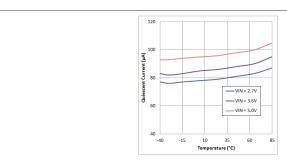


Figure 42. Buck2 Output Voltage Error vs Temperature



(BK1=1.1V, BK2=2.2V, LDO=1.8V, V_{INLDO} connect to V_{INBUCK})

Figure 43. Quiescent current vs temperature for active mode 3

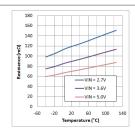


Figure 44. Buck1 high side $R_{DS(ON)}$ vs. temperature WLCSP-12

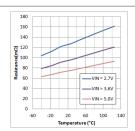


Figure 45. Buck2 high side $R_{DS(ON)}$ vs. temperature WLCSP-12

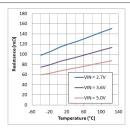


Figure 46. Buck1 low side $R_{DS(ON)}$ vs. temperature WLCSP-12

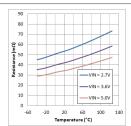


Figure 47. Buck2 low side $R_{DS(ON)}$ vs. temperature WLCSP-12

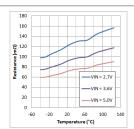


Figure 48. Buck1 high side $R_{DS(ON)}$ vs. temperature QFN-24

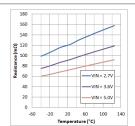


Figure 49. Buck2 high side $R_{DS(ON)}$ vs. temperature QFN-24

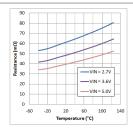


Figure 50. Buck1 low side $R_{DS(ON)}$ vs. temperature QFN-24

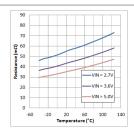


Figure 51. Buck2 low side $R_{DS(ON)}$ vs. temperature QFN-24

Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

8 Application information

8.1 PC board layout considerations and guidelines

Caution: To avoid abnormal noise and operating behavior follow these layout recommendations.

The PC board layout is very critical in any switching converter application. An improper layout can contribute to system instability, excessive EMI (electromagnetic interference), and high switching loss. Follow these basic guidelines to assure a good PCB layout:

- 1. Copy these layout guidelines within this section as much as possible including the use of the recommended BOM
- Before importing the net list into the layout tool, it is highly recommended to go through the board floor planning phase (the process defining the general location of components on the blank PCB before drawing in any traces).
 - a. It is highly recommended to allocate 40% or more of the layout schedule to dedicate for floor planning of the board.
 - b. Here are some of the questions that are commonly derived from the floor planning phase.

Where to place the SOC on the board? On the top or bottom layer? In the center?

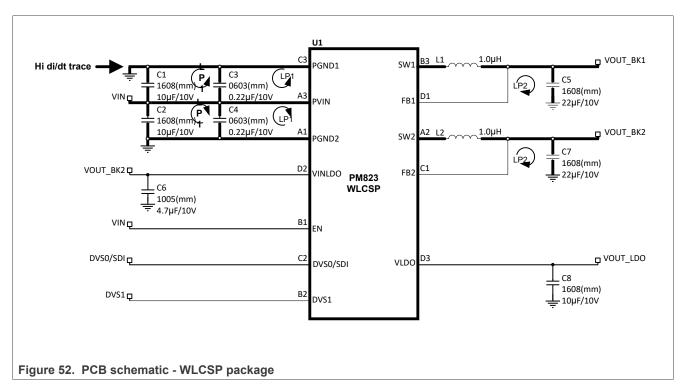
- c. After deciding where to place the SOC, the next step is to place the power management IC for the core voltage of the SOC.
- d. The optimum position to place the power management IC is on the same layer as the SOC. The output voltage of the power management IC should be close to the input voltage of the SOC.
- e. Continue this floor planning phase for the rest of the voltage rails before starting to layout the board.
- ATTENTION: Before starting to route any traces and after choosing where to place the power management IC on the board, the next step is to place the input capacitors.
 - a. Place input capacitor for the SVIN and SGND pins on the same layer as the IC.
 - b. Then, place input capacitor for the PVIN and PGND pins on the same layer as the IC.
 - c. Next, place the negative terminal for the output capacitors next to the negative terminal of the input capacitors.
 - d. See <u>Section 4.4 "Electrical characteristics "</u> for the recommended input and output capacitor values.
 - e. See <u>Section 4.4 "Electrical characteristics"</u> for the recommended distance between the IC and the input and output capacitors.
 - f. Do not place the inductor before placing the capacitors. The input capacitors placement is the most crucial for proper operation. The AC current circulating through the input capacitors, loop (LP1), is a square wave with rise and fall times as fast as 8ns (typical) with slew rates being as high as $300\mu\text{A}/\mu\text{s}$ (typical). At these fast slew rates, stray and parasitic PCB inductance can generate voltage spikes as high as 3V per inch of the PCB trace; $V_{\text{IND}} = L * \text{di/dt}$.

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- g. Keep loop 2 (LP2) as small as possible and connect the negative terminal of the output capacitor as close to the negative terminal of the input capacitor as possible.
- 4. The input capacitors for the SVIN and PVIN pins need to be Ceramic or equivalent low ESR capacitor.
 - a. Do not replace the Ceramic input or output capacitors with Tantalum capacitors.
 - b. Any type of capacitor can be placed in parallel with the input capacitor as long as the Ceramic input capacitor is placed next to the IC. If Tantalum input capacitors are used, it must be rated for switching regulator applications and the operating voltage must be de-rated by 50%.
 - c. Any type of capacitor can be placed in parallel with the output capacitor.
 - d. Low-ESR capacitors like the POSCAP from Sanyo can replace the Ceramic output capacitors as long as the capacitor value is the same or greater. Note that Ceramic capacitors provide the lowest noise and smallest foot print solution.
- 5. Use planes for the ground, input and output power to maintain good voltage filtering and to keep power losses low. If there is not enough space to place a power plane for the input sup-ply, then the input supply trace must be at least 3/8 of an inch wide.
- 6. Keep the switching and all sensitive traces away from the fast dv/dt to minimize capacitive coupling effects.

Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

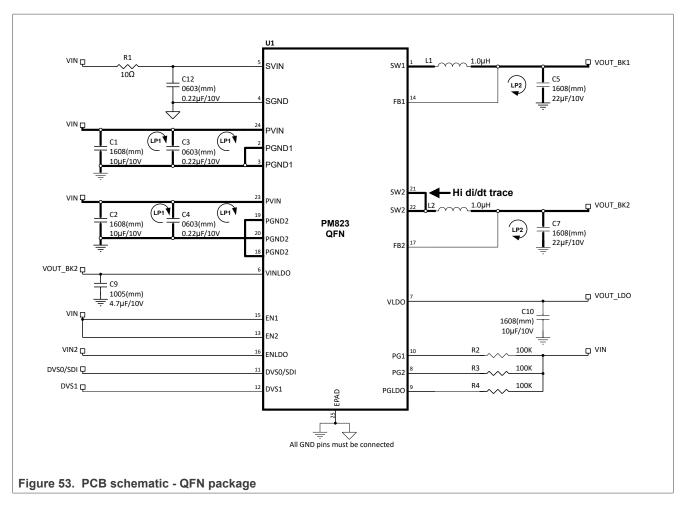
8.2 PCB schematics



Notes:

- For C3 and C4, can use 0.1 μ F but it is best to use maximum capacitance for the 0603(mm)/0201(in) case size. For example, 0.22 μ F is available 0603(mm)/0201(in) size.
- For all capacitors, use the highest voltage rating available for the case size. For example, 22 μ F is available in 1608(mm)/0603(in) case size with 6.3V and 10V rating. Use 22 μ F/10V rating instead of 22 μ F/6.3V rating
- See <u>Section 5.4 "Power-up sequence"</u> for the power sequence function
- See <u>Section 5.7 "DVS output voltage settings"</u> for DVS0 and DVS1 function and configuration. Do not float DVS/SDI and DVS1 pin.

Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO



Notes:

- For C3 and C4, can use 0.1µF but it is best to use maximum capacitance for the 0603(mm)/0201(in) case size. For example, 0.22µF is available 0603(mm)/0201(in) size
- For all capacitors, use the highest voltage rating available for the case size. For example, $22\mu F$ is available in 1608 (mm) / 0603 (in) case size with 6.3V and 10V rating. Use $22\mu F/10V$ rating instead of $22\mu F/6.3V$ rating
- For EN1, EN2, and ENLDO pins, can connect directly to VIN or through a 100K pull-up resistor if all outputs are turned on at the same time
- If the LDO output voltage comes after the Buck2 output, then connect VIN_LDO to VOUT2_BK2. Either have the ENLDO pin connect to VOUT_BK2 or connect through a 100K pull-up resistor.
- See Section 5.2 "Serial interface (1-wire)" for the SDI function and configuration
- See Section 5.4 "Power-up sequence" for the power sequence function
- See <u>Section 5.7 "DVS output voltage settings"</u> for DVS0 and DVS1 function and configuration. Do not float DVS0/SDI and DVS1 pin.

8.3 PCB layout examples

- WLCSP actual board size = 286 mil x 258 mil
- QFN actual board size = 409 mil x 510 mil

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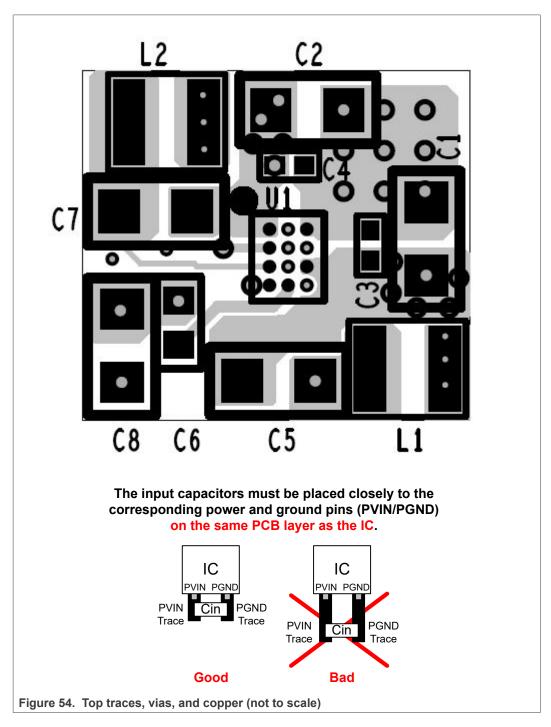
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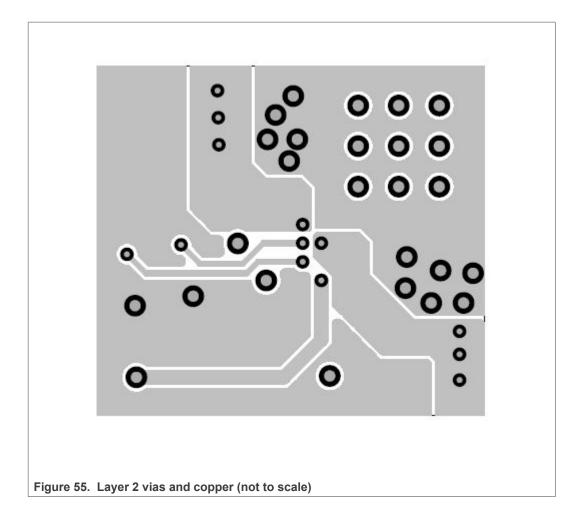
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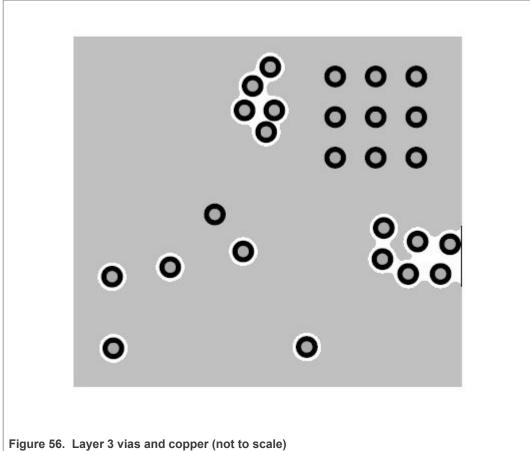
Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

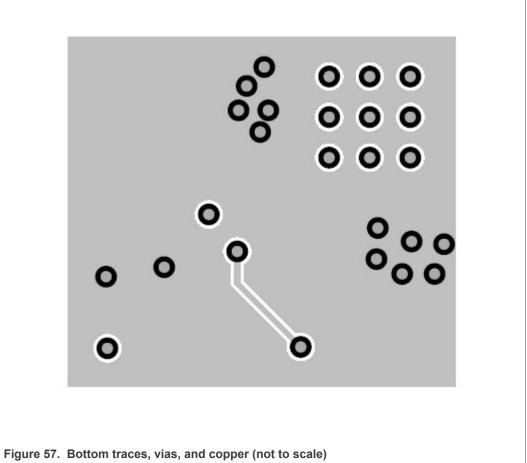
- WLCSP total copper layers = 4
- QFN total copper layers = 2

8.3.1 PCB layout for WLCSP package



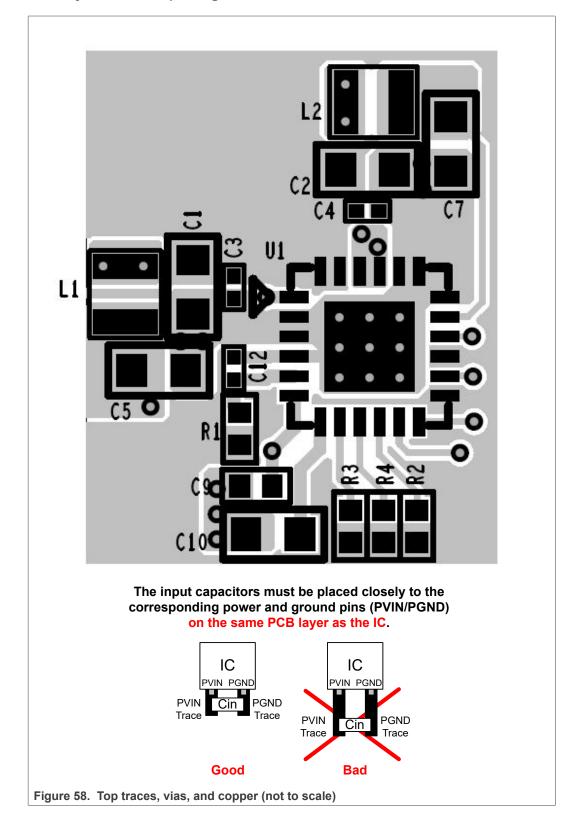


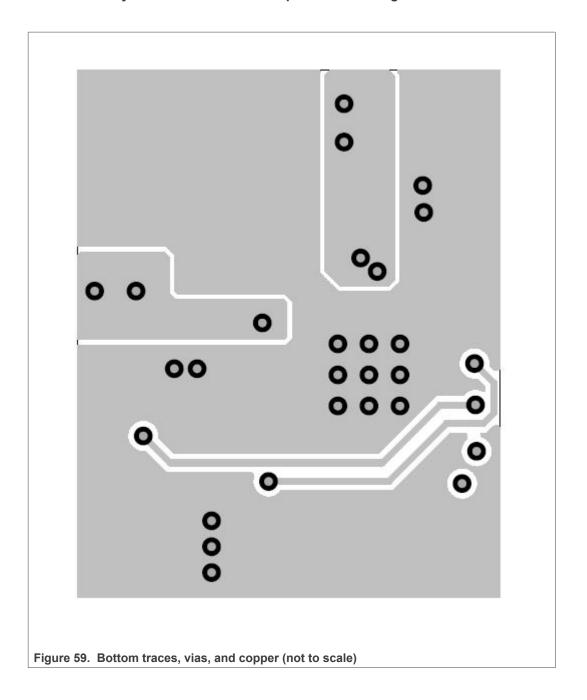




Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

8.3.2 PCB layout for QFN package





Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

8.4 Bill of materials (BOM)

Note:

Check component datasheets for the latest updates before designing these components in the schematic.

Check the maximum temperature of the applications and maximum heat source that these components will be placed next to. For example, these components might be placed near the SOC and the SOC might act as the heat source. This heat source can have a higher temperature than the ambient temperature. These recommended components are suitable for hand-held and portable applications. Components with high temperature ratings might be needed based on the maximum temperature of the application or the maximum heat source that these components will be subject to.

Table 10. BOM for WLCSP package

Item	Qty	Ref	Manufacturer part number	Manufacturer	Description	
1	3	C1,C2, C8	GRM188R61A106KE69D	Murata	CAP CER 10µF 10V ±10% X5R 1608(mm) / 0603(in)	
2	2	C3,C4	GRM033R61A224ME90D	Murata	CAP CER 0.22µF 10V ±20% X5R 0603(mm) / 0201(in)	
3	2	C5,C7	GRM188R61A226ME15	Murata	CAP CER 22µF 10V ±20% X5R 1608(mm) / 0603(in)	
4	1	C6	GRM155R61A475MEAA	Murata	CAP CER 4.7µF 10V ±20% X5R 1005(mm) / 0402(in)	
5	2	L1,L2	2 L1,L2 HEI2016	HEI201612A-1R0M-Q8D2	Chilisin	HEI201612A Series 1.0μH, L = 2.0mm, W = 1.6mm, H = 1.2mm
			MHCD201612A-1R0M-A8SDZ	Chilisin	MHCD201612A Series 1.0μH, L = 2.0mm, W = 1.6mm, H = 1.2mm	
6	1	U1	PM823	NXP	PM823 in WLCSP-12 package with dual synchronous bucks and LDO	

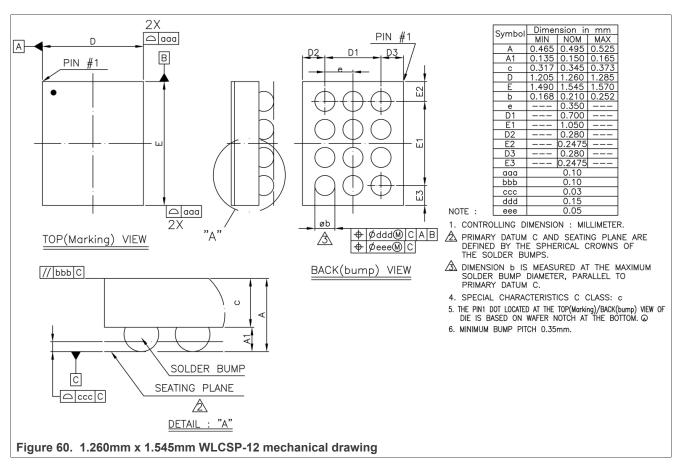
Table 11. BOM for QFN Package

Item	Qty	Ref	Manufacturer part number	Manufacturer	Description
1	3	C1,C2, C10	GRM188R61A106KE69	Murata	CAP CER 10µF 10V ±10% X5R 1608(mm) / 0603(in)
2	3	C3,C4, C12	GRM033R61A224ME90D	Murata	CAP CER 0.22μF 10V ±20% X5R 0603(mm) / 0201(in)
3	2	C5,C7	GRM188R61A226ME15 Murata CAP CER 22μF 10V ±20% 1608(mm) / 0603(in)		CAP CER 22µF 10V ±20% X5R 1608(mm) / 0603(in)
4	1	C9	·		CAP CER 4.7µF 10V ±20% X5R 1005(mm) / 0402(in)
5	2	L1,L2	HEI201612A-1R0M-Q8D2	Chilisin	HEI201612A Series 1.0μH, L = 2.0mm, W = 1.6mm, H = 1.2mm
			MHCD201612A-1R0M-A8SDZ	Chilisin	MHCD201612A Series 1.0μH, L = 2.0mm, W = 1.6mm, H = 1.2mm
6	1	R1	RC0402FR-0710RL	Yageo	RES 10Ω 1/16W ±1% 0402 SMD
7	3	R2,R3, R4	RC0402JR-07100KL	Yageo	RES 100kΩ 1/16W ±5% 0402 SMD
8	1	U1	PM823	NXP	PM823 in QFN-24 package with dual synchronous bucks and LDO

Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

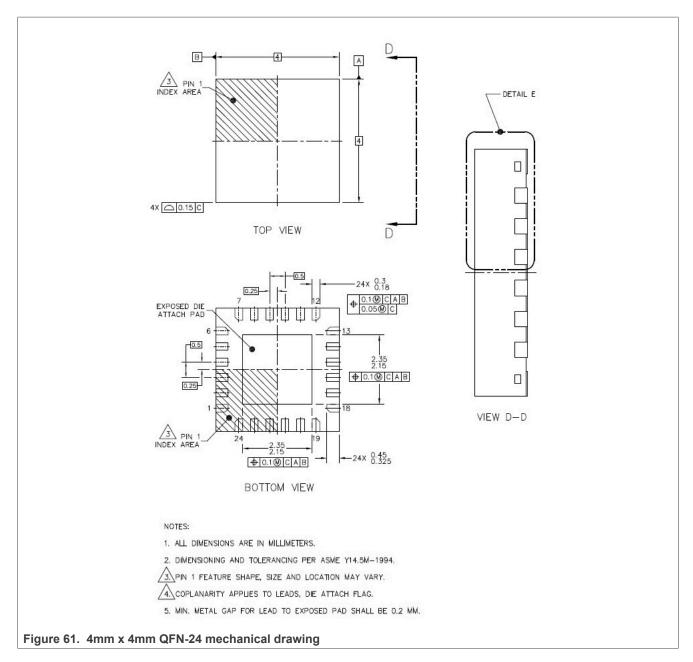
9 Package information

9.1 Package mechanical drawings

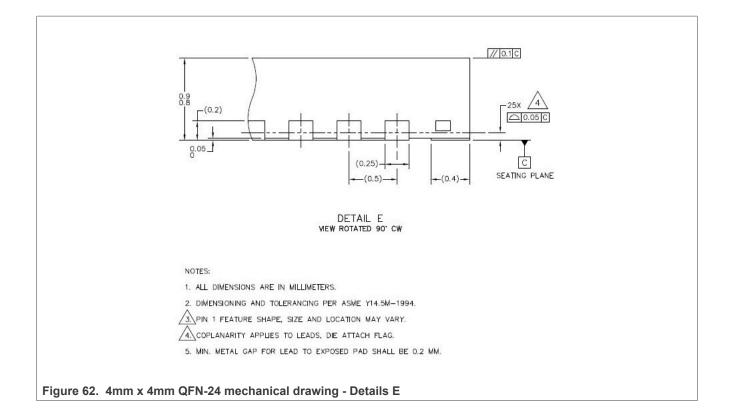


Note: All dimensions in mm. See <u>Section 9.2 "Package markings"</u> for package marking and pin 1 location.

Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

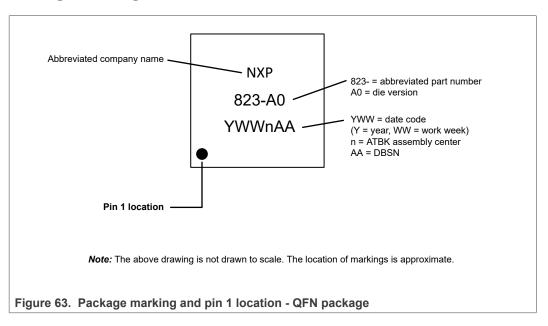


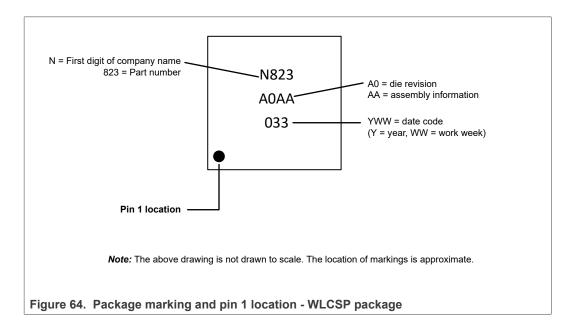
Note: All dimensions in mm. See <u>Section 9.2 "Package markings"</u> for package marking and pin 1 location.



Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

9.2 Package markings





Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

10 PM823 register sets

10.1 Register conventions

The register tables include the following information:

- Register address: included in the table caption
- Bits: Bits and/or bit fields
- Type: Read (R), write (W), read/write (RW)
- Default: Power-on hardware reset default value
- Description: Description of the bit or bit field and definition of the values

10.2 Register map

Table 12. Register map

Register name	Register address	Read / Write
Buck1 Active Mode 0 and Mode 3 Output Voltage Control	0x00	W
Buck1 Active Mode 1 Output Voltage Control	0x01	W
Buck1 Sleep Mode Output Voltage Control	0x02	W
Buck2 Output Voltage Control	0x03	W
LDO Output Voltage Control	0x04	W
MISC Control	0x05	W

10.3 Register descriptions

10.3.1 Buck1 active mode 1 and mode 3 output voltage control

Table 13. Register 0x00

	addition for integlection where						
Bit	Field	Type	Default	Description			
D[7]	EN_BK1_ ENABLE	W	1	Buck1 Software Enable 1: Buck1 is enabled 0: Buck1 is disabled			
D[6:5]	BK1_ VOUT_ RANGE	W	00	Buck1 V _{OUT} Range Used to set the Buck1 output voltage range 00: 0.6V ~ 1.375V 01: 1.4V ~ 2.85V 10: 2.9V ~ 3.3V 11: Reserved			

Table 13. Register 0x00...continued

Bit	Field	Туре	Default	Description				
D[4:0]	BK1_M0_	W	1_0100					
	VOUT			When the DVS1 input pin is high, Buck1 is set to Active Mode 0 and these register bits with the BK1_VOUT_RANGE register are used to set the Buck1 output voltage				
				BK1_VOUT_RANGE = 00	BK1_VOUT_RANGE = 01	BK1_VOUT_RANGE = 10		
				0_0000 = 0.6V	0_0000 = 1.4V	0_0000 = 2.9V		
				0_0001 = 0.625V	0_0001 = 1.425V	0_0001 = 2.95V		
				0_0010 = 0.65V	0_0010 = 1.45V	0_0010 = 3.0V		
				0_0011 = 0.675V	0_0011 = 1.475V	0_0011 = 3.05V		
				0_0100 = 0.7V	0_0100 = 1.5V	0_0100 = 3.1V		
				0_0101 = 0.725V	0_0101 = 1.55V	0_0101 = 3.15V		
				0_0110 = 0.75V	0_0110 = 1.6V	0_0110 = 3.2V		
				0_0111 = 0.775V	0_0111 = 1.65V	0_0111 = 3.25V		
				0_1000 = 0.8V	0_1000 = 1.7V	0_1000 = 3.3V		
				0_1001 = 0.825V	0_1001 = 1.75V	Others Reserved		
				0_1010 = 0.85V	0_1010 = 1.8V			
				0_1011 = 0.875V	0_1011 = 1.85V			
				0_1100 = 0.9V	0_1100 = 1.9V			
				0_1101 = 0.925V	0_1101 = 1.95V			
				0_1110 = 0.95V	0_1110 = 2.0V			
				0_1111 = 0.975V	0_1111 = 2.05V			
				1_0000 = 1.0V	1_0000 = 2.1V			
				1_0001 = 1.025V	1_0001 = 2.15V			
				1_0010 = 1.05V	1_0010 = 2.2V			
				1_0011 = 1.075V	1_0011 = 2.25V			
				1_0100 = 1.1V	1_0100 = 2.3V			
				1_0101 = 1.125V	1_0101 = 2.35V			
				1_0110 = 1.15V	1_0110 = 2.4V			
				1_0111 = 1.175V	1_0111 = 2.45V			
				1_1000 = 1.2V	1_1000 = 2.5V			
				1_1001 = 1.225V	1_1001 = 2.55V			
				1_1010 = 1.25V	1_1010 = 2.6V			
				1_1011 = 1.275V	1_1011 = 2.65V			
				1_1100 = 1.3V	1_1100 = 2.7V			
				1_1101 = 1.325V	1_1101 = 2.75V			
				1_1110 = 1.35V	1_1110 = 2.8V			
				1_1111 = 1.375V	1_1111 = 2.85V			

Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

10.3.2 Buck1 active mode 2 output voltage control

Table 14. Register 0x01

Bit	Field	Type	Default	Description					
D[7:5]	Reserved	W	000	Reserved Set bits to 0 when written					
D[4:0]	BK1_M1_	W	1_0100	Buck1 Active Mode 1 Out	put Voltage				
	VOUT			When the DVS1=0 and DVS0=1 register bit is set to 1, Buck1 is set to Active Mode 0 and these register bits with the BK1_VOUT_RANGE register are used to set the Buck1 output voltage					
				BK1_VOUT_RANGE = 00	BK1_VOUT_RANGE = 01	BK1_VOUT_RANGE = 10			
				0_0000 = 0.6V	0_0000 = 1.4V	0_0000 = 2.9V			
				0_0001 = 0.625V	0_0001 = 1.425V	0_0001 = 2.95V			
				0_0010 = 0.65V	0_0010 = 1.45V	0_0010 = 3.0V			
				0_0011 = 0.675V	0_0011 = 1.475V	0_0011 = 3.05V			
				0_0100 = 0.7V	0_0100 = 1.5V	0_0100 = 3.1V			
				0_0101 = 0.725V	0_0101 = 1.55V	0_0101 = 3.15V			
				0_0110 = 0.75V	0_0110 = 1.6V	0_0110 = 3.2V			
				0_0111 = 0.775V	0_0111 = 1.65V	0_0111 = 3.25V			
				0_1000 = 0.8V	0_1000 = 1.7V	0_1000 = 3.3V			
				0_1001 = 0.825V	0_1001 = 1.75V	Others Reserved			
				0_1010 = 0.85V	0_1010 = 1.8V				
				0_1011 = 0.875V	0_1011 = 1.85V				
				0_1100 = 0.9V	0_1100 = 1.9V				
				0_1101 = 0.925V	0_1101 = 1.95V				
				0_1110 = 0.95V	0_1110 = 2.0V				
				0_1111 = 0.975V	0_1111 = 2.05V				
				1_0000 = 1.0V	1_0000 = 2.1V				
				1_0001 = 1.025V	1_0001 = 2.15V				
				1_0010 = 1.05V	1_0010 = 2.2V				
				1_0011 = 1.075V	1_0011 = 2.25V				
				1_0100 = 1.1V	1_0100 = 2.3V				
				1_0101 = 1.125V	1_0101 = 2.35V				
				1_0110 = 1.15V	1_0110 = 2.4V				
				1_0111 = 1.175V	1_0111 = 2.45V				
				1_1000 = 1.2V	1_1000 = 2.5V				
				1_1001 = 1.225V	1_1001 = 2.55V				
				1_1010 = 1.25V	1_1010 = 2.6V				
				1_1011 = 1.275V	1_1011 = 2.65V				
				1_1100 = 1.3V	1_1100 = 2.7V				
				1_1101 = 1.325V	1_1101 = 2.75V				
				1_1110 = 1.35V	1_1110 = 2.8V				
				1_1111 = 1.375V	1_1111 = 2.85V				

Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

10.3.3 Buck1 sleep mode output voltage control

Table 15. Register 0x02

Bit	Field	Type	Default	Description					
D[7:5]	Reserved	W	000	Reserved					
				Set bits to 0 when written					
D[4:0]	H:0] BK1_SLP_ W 1_0100 VOUT			When the DVS1=0 and DVS to Active Mode 0 and these	Buck1 Sleep Mode Output Voltage When the DVS1=0 and DVS0=0 and DVS_EN register bit is set to 1, Buck1 is set to Active Mode 0 and these register bits with the BK1VOUT_RANGE register are used to set the Buck1 output voltage				
				BK1_VOUT_RANGE = 00	BK1_VOUT_RANGE = 01	BK1-VOUT_RANGE = 10			
				0_0000 = 0.6V 0_0001 = 0.625V 0_0010 = 0.65V 0_0011 = 0.675V 0_0100 = 0.7V 0_0101 = 0.725V 0_0110 = 0.75V 0_0111 = 0.775V 0_1000 = 0.8V 0_1001 = 0.825V 0_1010 = 0.85V 0_1011 = 0.875V 0_1100 = 0.9V 0_1101 = 0.925V 0_1110 = 0.95V 0_1111 = 0.975V 1_0000 = 1.0V 1_0001 = 1.025V 1_0010 = 1.05V 1_0101 = 1.125V 1_0110 = 1.15V 1_0111 = 1.175V 1_1010 = 1.25V 1_1000 = 1.2V 1_1001 = 1.225V 1_1010 = 1.25V 1_1010 = 1.25V 1_1010 = 1.25V 1_1010 = 1.25V 1_1010 = 1.25V 1_1010 = 1.25V	0_0000 = 1.4V 0_0001 = 1.425V 0_0010 = 1.45V 0_0011 = 1.475V 0_0100 = 1.5V 0_0101 = 1.55V 0_0110 = 1.6V 0_0111 = 1.65V 0_1000 = 1.7V 0_1001 = 1.75V 0_1010 = 1.8V 0_1011 = 1.85V 0_1101 = 1.95V 0_1101 = 1.95V 0_1110 = 2.0V 0_1111 = 2.05V 1_0000 = 2.1V 1_0001 = 2.15V 1_0010 = 2.2V 1_011 = 2.25V 1_010 = 2.3V 1_0101 = 2.35V 1_0110 = 2.4V 1_0111 = 2.45V 1_1000 = 2.5V 1_1000 = 2.5V 1_1000 = 2.5V 1_1000 = 2.5V 1_1010 = 2.6V 1_1010 = 2.6V 1_1010 = 2.6V 1_1010 = 2.6V	0_0000 = 2.9V 0_0001 = 2.95V 0_0010 = 3.0V 0_0101 = 3.05V 0_0100 = 3.1V 0_0101 = 3.2V 0_0111 = 3.25V 0_1000 = 3.3V Others Reserved			
				1_1100 = 1.3V 1_1101 = 1.325V 1_1110 = 1.35V 1_1111 = 1.375V	1_1100 = 2.7V 1_1101 = 2.75V 1_1110 = 2.8V 1_1111 = 2.85V				

Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

10.3.4 Buck2 output voltage control

Table 16. Register 0x03

Field	Type	Default	Description			
EN_BK2_ ENABLE	W	1	Buck2 Software Enable 1: Buck2 is enabled 0: Buck2 is disabled			
BK2_ VOUT	W	1_0100	Buck2 Output Voltage Used to control the Buck2 output voltage			
			0_0000 = 0.6V 0_0001 = 0.625V 0_0010 = 0.65V 0_0011 = 0.675V 0_0100 = 0.7V 0_0101 = 0.725V 0_0110 = 0.75V 0_0111 = 0.775V 0_1000 = 0.8V 0_1001 = 0.825V 0_1010 = 0.85V 0_1011 = 0.875V 0_1100 = 0.9V 0_1101 = 0.95V 0_1101 = 0.95V 0_1111 = 0.975V 1_0000 = 1.0V 1_0001 = 1.025V 1_0010 = 1.05V 1_0101 = 1.125V 1_0100 = 1.1V 1_0101 = 1.125V 1_0110 = 1.25V 1_1000 = 1.2V 1_1000 = 1.2V 1_1001 = 1.25V 1_1001 = 1.25V 1_1001 = 1.25V 1_1001 = 1.25V 1_1001 = 1.25V 1_1001 = 1.25V 1_1100 = 1.35V 1_1101 = 1.325V 1_1101 = 1.325V 1_11101 = 1.325V 1_11101 = 1.325V	0_0000 = 1.4V 0_0001 = 1.425V 0_0010 = 1.45V 0_0011 = 1.475V 0_0100 = 1.5V 0_0101 = 1.6V 0_0110 = 1.6V 0_0111 = 1.65V 0_1000 = 1.7V 0_1001 = 1.75V 0_1010 = 1.8V 0_1011 = 1.85V 0_1101 = 1.95V 0_1101 = 1.95V 0_1101 = 2.0V 0_1111 = 2.05V 1_0000 = 2.1V 1_0001 = 2.15V 1_0011 = 2.25V 1_0101 = 2.3V 1_0101 = 2.35V 1_0101 = 2.35V 1_0110 = 2.4V 1_0111 = 2.45V 1_0111 = 2.45V 1_1001 = 2.55V 1_1001 = 2.55V 1_1001 = 2.55V 1_1001 = 2.6V 1_1100 = 2.7V 1_1101 = 2.75V 1_1101 = 2.75V 1_1101 = 2.75V 1_11101 = 2.8V	0_0000 = 2.9V 0_0001 = 2.95V 0_0010 = 3.0V 0_0100 = 3.1V 0_0101 = 3.15V 0_0110 = 3.2V 0_0111 = 3.25V 0_1000 = 3.3V Others Reserved	
	EN_BK2_ ENABLE BK2_	EN_BK2_ W ENABLE BK2_ W	EN_BK2_ W 1 ENABLE W 1_0100	EN_BK2_ ENABLE BK2_ VOUT Suck2 Software Enable	EN_BK2_ ENABLE Name	

Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

10.3.5 LDO output voltage control

Table 17. Register 0x04

Bit	Field	Type	Default	Description
D[7:5]	Reserved	W	000	Reserved Set bits to 0 when written
D[4]	EN_LDO	W	1	LDO Software Enable 1: LDO is enabled 0: LDO is disabled
D[3:0]	LDO_VOUT	W	1000	LDO Output Voltage Setting Used to set the LDO output voltage as follows
				0000 = 1.6V 0001 = 1.625V 0010 = 1.65V 0011 = 1.675V 0100 = 1.7V 0101 = 1.725V 0110 = 1.75V 0111 = 1.775V 1000 = 1.8V 1001 = 1.825V 1010 = 1.85V 1011 = 1.875V 1100 = 1.9V 1101 = 1.925V 1111 = 1.975V

10.3.6 Miscellaneous control

Table 18. Register 0x05

Bit	Field	Туре	Default	Description
D[7:3]	Reserved	W	0000_0	Reserved Set bits to 0 when written
D[2]	DVS_EN	W	0	DVS Enable 1: DVS is enabled 0: DVS is disabled
D[1]	FPWM_BK1	W	0	Buck1 FPWM 1: When set, forces PWM mode 0: Auto switch between PWM and PFM modes
D[0]	FPWM_BK2	W	0	Buck2 FPWM 1: When set, forces PWM mode 0: Auto switch between PWM and PFM modes

Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

11 Revision history

Table 19. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes				
PM823 v4.0	20220623	Product data sheet	-	PM823 v3.0				
Modifications	_	Changed the document confidentiality level from "Company Confidential" to "Public". No changes in the content.						
PM823 v3.0	20210524	Product data sheet	-	PM823 v2.0				
Modifications	 Figure 4 "1.26 Application info Figure 53 "PCI Package inform Section 9.2 "Page 1.26 	Signal description Figure 4 "1.26 mm x 1.545 mm WLCSP-12 lead, pop (see through) view": corrected Application information Figure 53 "PCB schematic - QFN package": corrected Package information Section 9.2 "Package markings": updated with the marking of QFN (Figure 63) and WLCSP (Figure 64) packages						
PM823 v2.0	20210512	Product data sheet	-	PM823 v1.0				
Modifications		Signal description • Figure 5 "4 mm x 4 mm QFN-24 in 0.5 mm pitch pin configuration, top (see through) view": corrected						
PM823 v1.0	20201118	Objective data sheet	-	-				

Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

12 Legal information

12.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Dual Synchronous 1.5A/1.5A Step-down Buck Regulators with 525 mA LDO

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